

## **Dual N-channel MOSFET**

## FCAB22710L Datasheet

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#### 1. GENERAL DESCRIPTION

Dual N-channel MOSFET.

### 2. FEATURES

- Source-source On-state Resistance: RSS(on) typ = 7.5 m $\Omega$  (VGS = 3.8 V)
- CSP (Chip Size Package)
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL: Level 1)

### 3. MARKING SYMBOL: WJ

#### 4. PACKAGING

Embossed type (Thermo-compression sealing): 10,000 pcs / reel (standard)

#### 5. ABSOLUTE MAXIMUM RATINGS Ta = 25 °C

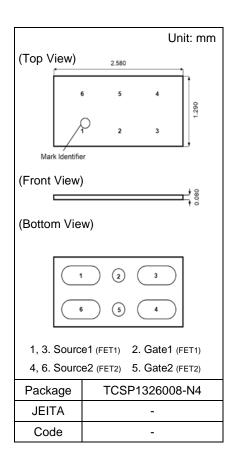
Parameter	Symbol	Rating	Unit	
Source-source Voltage		VSS	20	V
Gate-source Voltage		VGS	± 12	V
	DC *1	IS1	6.1	
Source Current	DC *2	IS2	10.9	Α
Source Current	DC *3	IS3	15.0	A
	Pulsed*4	ISp	61.0	
	DC *1	PD1	0.51	
Total Power Dissipation	DC *2	PD2	1.60	W
	DC *3	PD3	3.00	
Operating Junction and Storage Temperature Range		Tj, Tstg	- 55 to + 150	°C

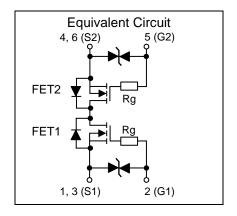
## 6. THERMAL CHARACTERISTICS Ta = 25 °C

Parameter	Symbol	Rating	Unit
	Rth1 *1	245	
Thermal Resistance (ch-a)	Rth2 *2	78	°C/W
	Rth3 *3	41	

Note \*1 Mounted on FR4 board (25.4 mm x 25.4 mm x t1.0 mm). FR4 board partially covered with copper pad (22 mm² area, 36 µm thickness).

- \*2 Mounted on FR4 board (25.4 mm x 25.4 mm x t1.0 mm). FR4 board fully covered with copper pad (602 mm² area, 36 µm thickness).
- \*3 Mounted on ceramic board (70 mm x 70 mm x t1.0 mm).
- \*4  $t = 10 \mu s$ , Duty Cycle  $\leq 1 \%$ .







## 7. ELECTRICAL CHARACTERISTICS Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Source-source Breakdown Voltage	VSSS	IS = 1 mA, VGS = 0 V	12			V
Zero Gate Voltage Source Current	ISSS	VSS = 20 V, VGS = 0 V			1	μΑ
Cata aguras Lagkaga Current	IGSS1	VGS = ± 8 V, VSS = 0 V			± 10	
Gate-source Leakage Current	IGSS2	VGS = ± 5 V, VSS = 0 V			± 1	μA
Gate-source Threshold Voltage	Vth	IS = 0.54 mA, VSS = 10 V	1.30	1.85	2.35	V
	RSS(on)1	IS = 3.05 A, VGS = 4.5 V	3.9	5.5	7.5	mΩ
Source-source On-state Resistance	RSS(on)2	IS = 3.05 A, VGS = 3.8 V	5.3	7.5	12.5	11177
	RSS(on)3	IS = 0.20 A, VGS = 3.1 V	5.4	16.5	70.0	
Body Diode Forward Voltage	VF(s-s)	IF = 3.05 A, VGS = 0 V		0.8	1.2	V
Turn-on Delay Time *1,*2	td(on)	VDD = 10 V, VGS = 0 to 4 V		62		200
Rise Time *1, *2	tr	IS = 3.05 A		240		ns
Turn-off Delay Time *1,*2	td(off)	VDD = 10 V, VGS = 4 to 0 V		155		20
Fall Time *1, *2	tf	IS = 3.05 A		140		ns
Total Gate Charge *1	Qg	VDD = 10 V		17.5		
Gate-source Charge *1	Qgs	VGS = 0 to 4 V		6.5		nC
Gate-drain Charge *1	Qgd	IS = 6.1 A		6.5		
Gate Resistance *1	Rg	f = 1 MHz		24.5		Ω

(MOSFET: FET1)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Input Capacitance *1	Ciss			2320		
Output Capacitance *1	Coss	VSS = 10 V, f = 1 kHz VGS1 = 0 V. VGS2 = 6 V		265		pF
Reverse Transfer Capacitance *1	Crss	V 001 = 0 V, V 002 = 0 V		205		

## (MOSFET: FET2)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Input Capacitance *1	Ciss			2320		
Output Capacitance *1	Coss	VSS = 10 V, f = 1 kHz VGS2 = 0 V. VGS1 = 6 V		265		pF
Reverse Transfer Capacitance *1	Crss	1 1352 = 3 1, 1331 = 3 1		205		

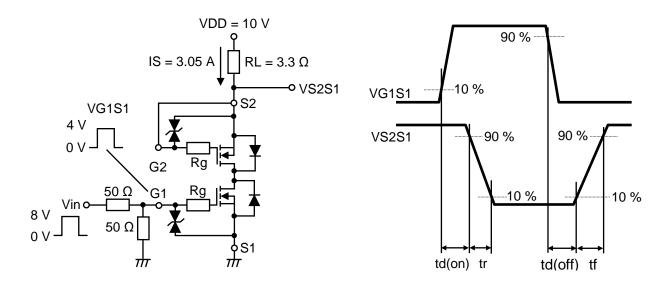
Note Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

<sup>\*1</sup> Guaranteed by design, not subject to production testing.

<sup>\*2</sup> Measurement circuit for Turn-on Delay Time / Rise Time / Turn-off Delay Time / Fall Time.



Measurement circuit for Turn-on Delay Time / Rise Time / Turn-off Delay Time / Fall Time

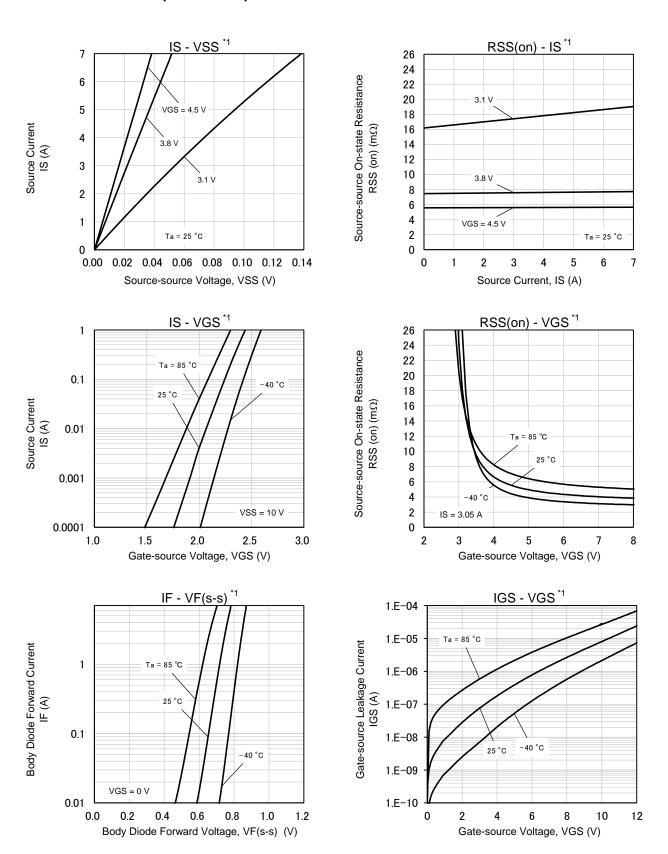


## 8. ELECTROSTATIC DISCHARGE CHARACTERISTIC Ta = 25 °C ± 3 °C

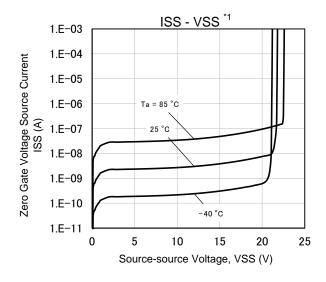
Standard	Test Type	Symbol	Conditions	Class	Value	Unit
AEC-Q101-001	Human Body Model	HBM	$C = 100 \text{ pF}, R = 1.5 \text{ k}\Omega$	H1B	> 0.5 to ≤ 1	kV

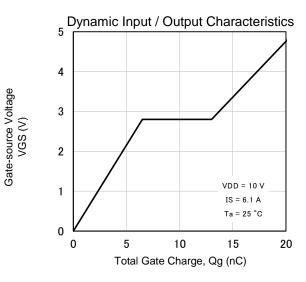


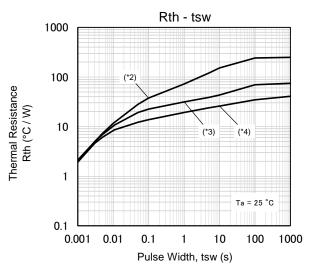
## 9. TECHNICAL DATA (Reference)

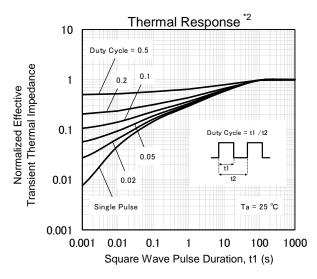


## **TECHNICAL DATA (Reference)**







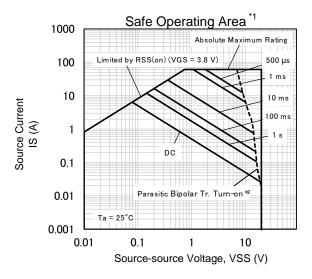


#### Note

- \*1 Pulse measurement.
- \*2 Mounted on FR4 board (25.4 mm x 25.4 mm x t1.0 mm). FR4 board partially covered with copper pad (22 mm² area, 36 µm thickness).
- \*3 Mounted on FR4 board (25.4 mm x 25.4 mm x t1.0 mm). FR4 board fully covered with copper pad (602 mm² area, 36 µm thickness).
- \*4 Mounted on ceramic board (70 mm x 70 mm x t1.0 mm).

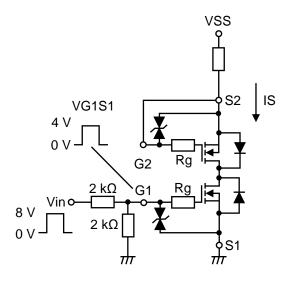


## **TECHNICAL DATA (Reference)**



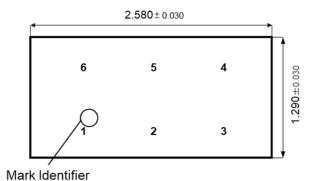
#### Note

- \*1 Mounted on FR4 board (25.4 mm x 25.4 mm x t1.0 mm). FR4 board partially covered with copper pad (22 mm² area, 36 µm thickness).
- \*2 Measurement circuit for Parasitic Bipolar Tr. Turn-on.



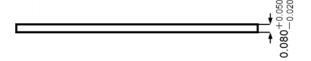
## 10. OUTLINE

(Top View)

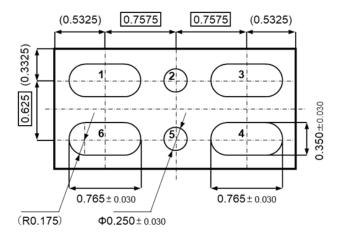


Unit: mm

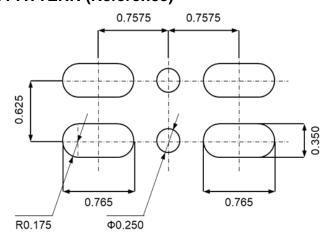
(Front View)



(Bottom View)



## 11. LAND & STENCIL PATTERN (Reference)



Unit: mm

#### Important notice:

Solder Mask Defined (SMD) pattern is strongly recommended for pad design.

Please check the information in the Nuvoton WL-CSP Application Notes about mounting process.



## **12. REVISION HISTORY**

Date	Revision	Description			
2021.06.09	1.00	1. Initially issued.			
2021.08.31	1.01	Added important notice in Land Pattern.			
	1.01	2. Added special attention and precautions notes.			
2021.11.11	1.02	<ol> <li>Changed document name from Product Standards to Datasheet.</li> </ol>			



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